## **AMENDMENTS TO THE SPECIFICATION**

Please amend paragraph 0007 as indicated below:

-- In one embodiment, the computer chassis includes a plurality of air outlets located far from the [[to]] electronic components on the motherboard that generate a relatively large amount of heat, thereby avoiding a hotter air flow near those components. Alternatively or in addition, these air outlets are located near elements on the motherboard for which less heat dissipation is desired, thereby causing a hotter air flow near those elements. --